

1W, 3W SMT Ceramic Package Top View  
Neutral White LED  
Technical Data Sheet

Part No.: C3535W-W5H-Q90

## Features:

- Small SMT ceramic package with high efficiency.
- Maximum drive current up to 700mA.
- ESD protection up to 8KV.
- Low thermal resistance as low as 4 /W.
- Wide viewing angle.
- Soldering method: SMT.
- Binning Parameters: Brightness, Forward.
- Voltage, Wavelength and Chromaticity.
- Moisture Sensitivity Level: 1.
- Matches ANSI binning.
- Reliability testing conforms to IESNA LM80.
- Lumen maintenance test method.
- Reflow soldering with JEDEC JSTD-020C compatible.
- The product itself will remain within RoHS compliant Version.

## Descriptions:

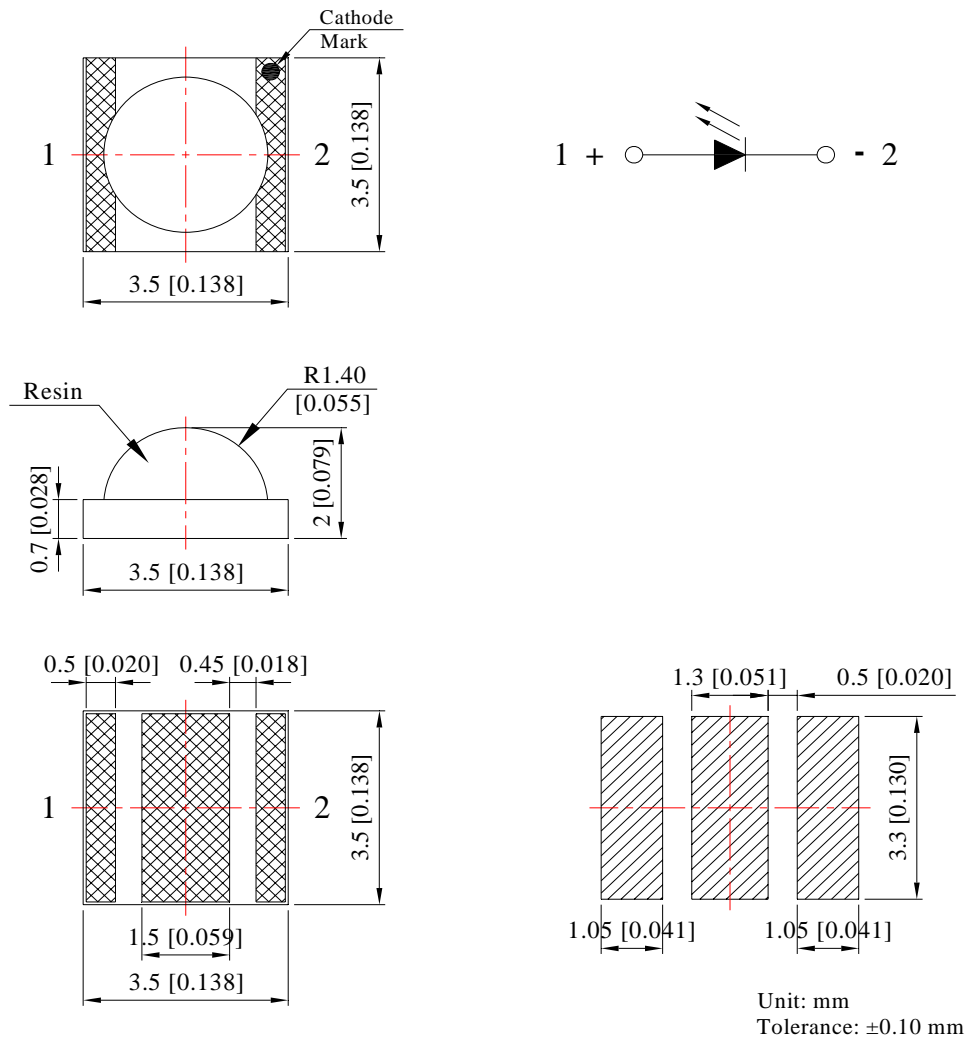
The C3535 series is a surface-mount high-power device featuring high brightness combined with a compact size that is suitable for all kinds of lighting applications such as general illumination, flash, spot, signal, industrial and commercial lighting. The thermal pad of this device is electrically isolated providing convenience in thermal and electrical design.

The C3535 series is one of the most promising devices in **Lucky Light's** high power product offering and is ready to face the challenges of today's Solid-State Lighting requirements.

## Applications:

- General Lighting.
- General luminaire.
- Decorative and Entertainment Lighting.
- Signal and Symbol Luminaries for orientation marker lights (e.g. steps, exit ways, etc.).
- Exterior and Interior Automotive.
- Illumination.
- Agriculture Lighting.
- Bulb.
- Downlight.

### Package Dimension:



Part No.	Chip Material	Lens Color	Emitting Color
C3535W-W5H-Q90	InGaN	Yellow Diffused	Neutral White

#### Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is  $\pm 0.10$ mm (.004") unless otherwise specified.
3. Specifications are subject to change without notice.

### Absolute Maximum Ratings at Ta=25

Parameters	Symbol	Max.	Unit
Power Dissipation	PD	1/3	W
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	IFP	500/1000	mA
Continuous Forward Current	IF	350/700	mA
Reverse Voltage	VR	5	V
Electrostatic Discharge (HBM)	ESD	8000	V
LED Junction Temperature	Tj	120	
Operating Temperature Range	Topr	-40 to +85	
Storage Temperature Range	Tstg	-40 to +100	
Soldering Temperature	Tsld	260 for 5 Seconds	

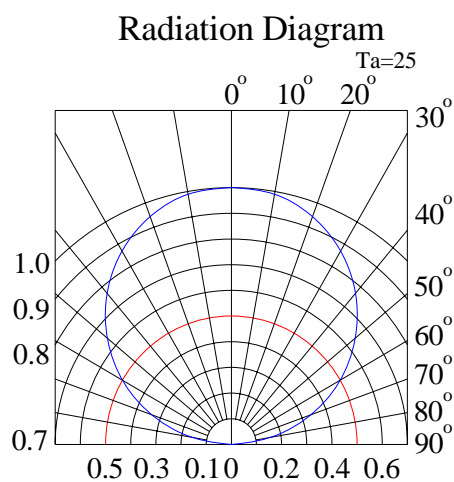
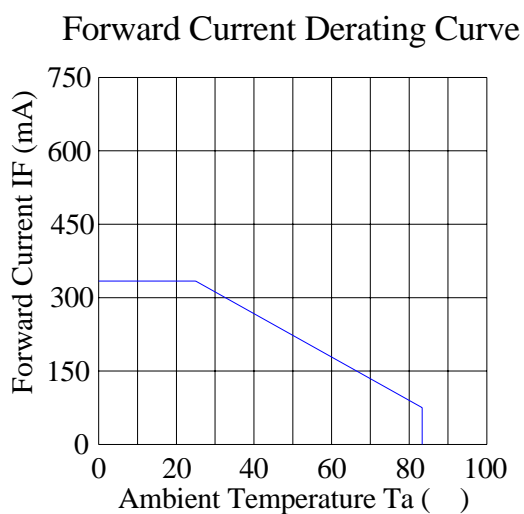
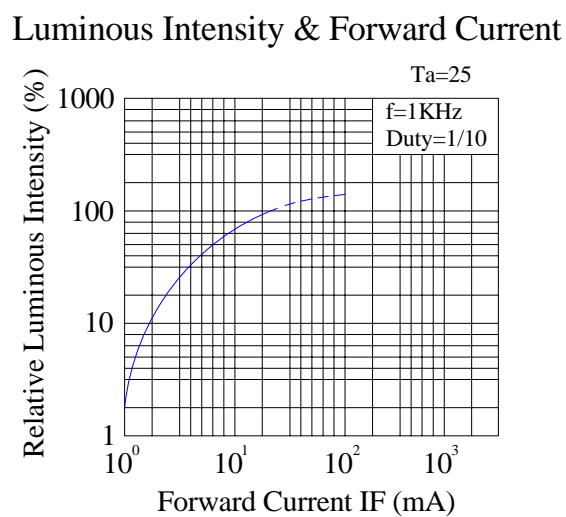
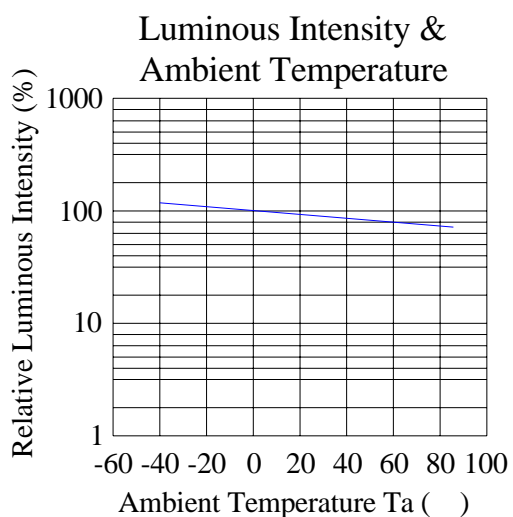
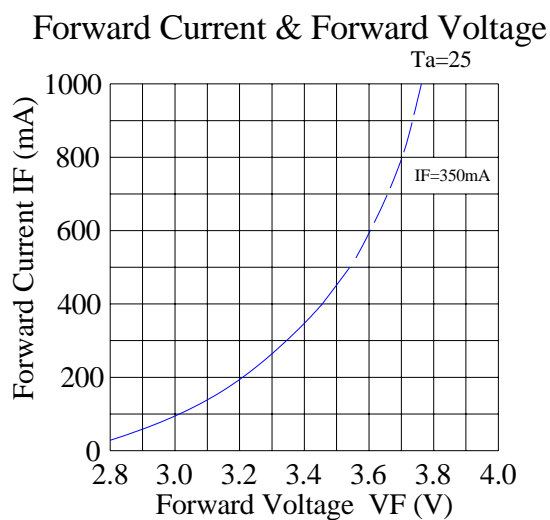
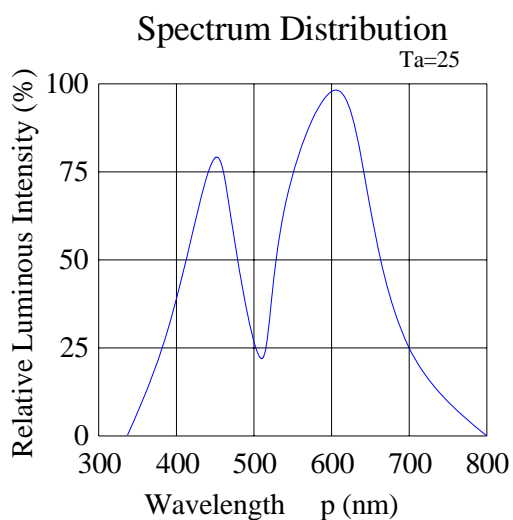
### Electrical Optical Characteristics at Ta=25

Parameters	Symbol	Min.	Typ.	Max.	Unit	Test Condition
Luminous Flux *	$\Phi_v$	90	110	---	lm	IF=350mA
		160	180	---	lm	IF=700mA
Viewing Angle *	$2\theta_{1/2}$	---	120	---	Deg	IF=350mA
Chromaticity Coordinates	X	---	0.35	---		IF=350mA
	Y	---	0.36	---		
Color Temperature	CCT	3800	4500	5000	K	IF=350mA
Color Rendering Index	CRI	---	75	---	Ra	IF=350mA
Forward Voltage	VF	2.80	3.40	4.00	V	IF=350mA
Reverse Current	IR	---	---	50	$\mu$ A	VR=5V

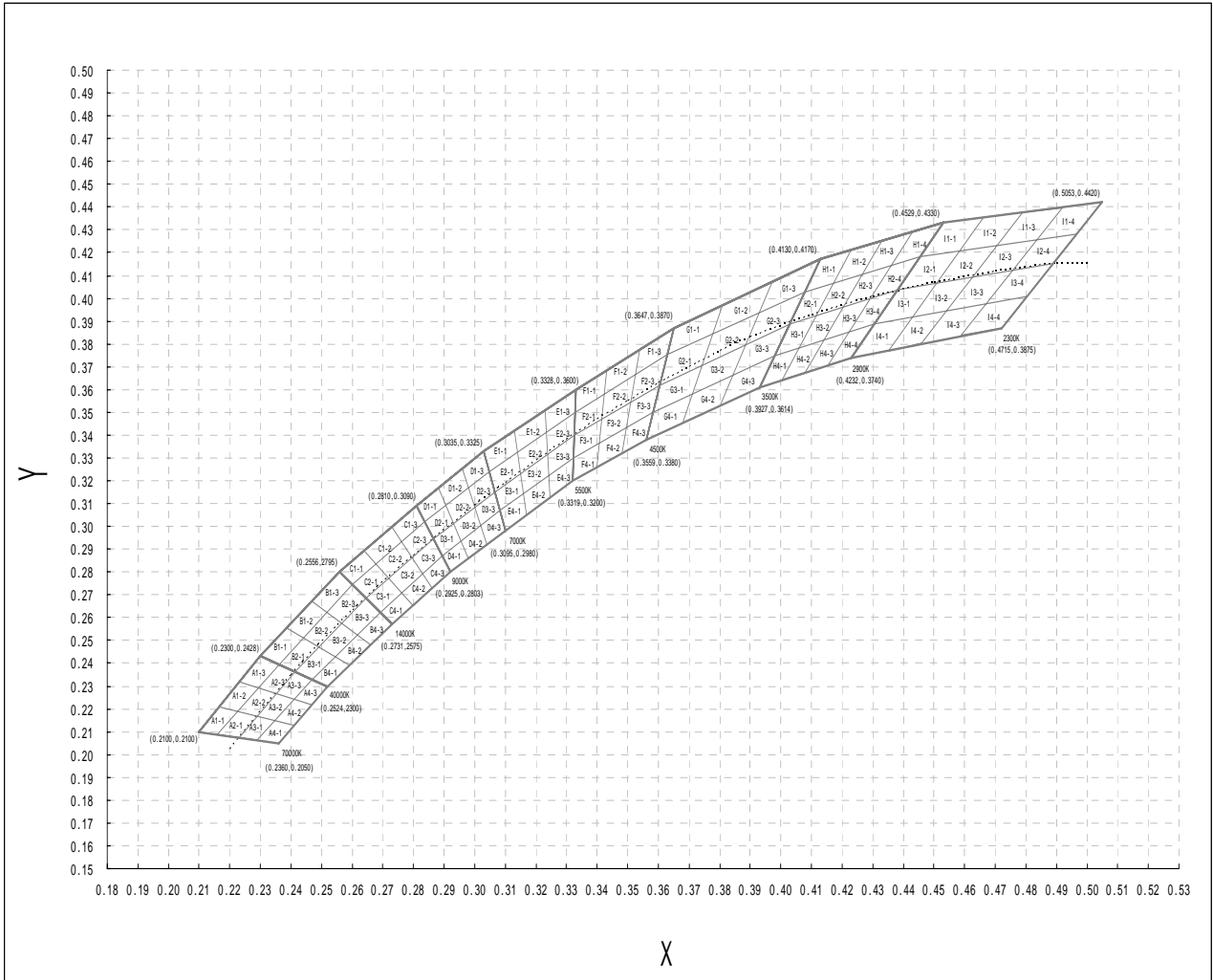
#### Notes:

1. Luminous Intensity (Flux) Measurement allowance is  $\pm 10\%$ .
2.  $\theta_{1/2}$  is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
3. It use many parameters that correspond to the CIE 1931 2°. X, Y, and Z are CIE 1931 2° values of Red, Green and Blue content of the measurement.

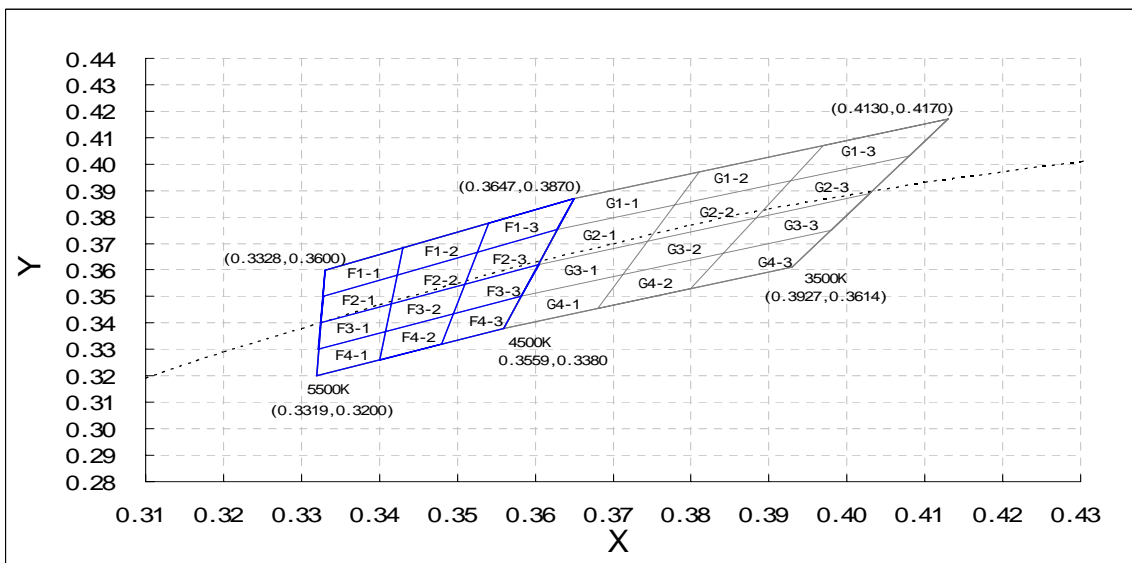
Typical Electrical / Optical Characteristics Curves  
(25 Ambient Temperature Unless Otherwise Noted)



### CIE 1931 Chromaticity Diagram:



### W5:



### Chromaticity Coordinates Specifications for Bin Rank:

Bin Code	Left x	Left y	Top x	Top y	Right x	Right y	Bottom x	Bottom y
F1-1	0.3330	0.3600	0.3430	0.3690	0.3430	0.3580	0.3330	0.3500
F2-1	0.3330	0.3500	0.3430	0.3580	0.3420	0.3480	0.3320	0.3400
F3-1	0.3320	0.3400	0.3420	0.3480	0.3410	0.3370	0.3320	0.3300
F4-1	0.3320	0.3300	0.3410	0.3370	0.3400	0.3260	0.3320	0.3200
F1-2	0.3430	0.3690	0.3540	0.3780	0.3530	0.3660	0.3430	0.3580
F2-2	0.3430	0.3580	0.3530	0.3660	0.3510	0.3550	0.3420	0.3480
F3-2	0.3420	0.3480	0.3510	0.3550	0.3490	0.3430	0.3410	0.3370
F4-2	0.3410	0.3370	0.3490	0.3430	0.3480	0.3320	0.3400	0.3260
F1-3	0.3540	0.3780	0.3650	0.3870	0.3620	0.3750	0.3530	0.3660
F2-3	0.3530	0.3660	0.3620	0.3750	0.3600	0.3620	0.3510	0.3550
F3-3	0.3510	0.3550	0.3600	0.3620	0.3580	0.3500	0.3490	0.3430
F4-3	0.3490	0.3430	0.3580	0.3500	0.3560	0.3380	0.3480	0.3320
G1-1	0.3650	0.3870	0.3810	0.3970	0.3780	0.3840	0.3620	0.3750
G2-1	0.3620	0.3750	0.3780	0.3840	0.3740	0.3710	0.3600	0.3620
G3-1	0.3600	0.3620	0.3740	0.3710	0.3710	0.3590	0.3580	0.3500
G4-1	0.3580	0.3500	0.3710	0.3590	0.3680	0.3460	0.3560	0.3380
G1-2	0.3810	0.3970	0.3970	0.4070	0.3930	0.3940	0.3780	0.3840
G2-2	0.3780	0.3840	0.3930	0.3940	0.3890	0.3800	0.3740	0.3710
G3-2	0.3740	0.3710	0.3890	0.3800	0.3850	0.3670	0.3710	0.3590
G4-2	0.3710	0.3590	0.3850	0.3670	0.3800	0.3540	0.3680	0.3460
G1-3	0.3970	0.4070	0.4130	0.4170	0.4080	0.4030	0.3930	0.3940
G2-3	0.3930	0.3940	0.4080	0.4030	0.4030	0.3890	0.3890	0.3800
G3-3	0.3890	0.3800	0.4030	0.3890	0.3980	0.3750	0.3850	0.3670
G4-3	0.3850	0.3670	0.3980	0.3750	0.3930	0.3610	0.3800	0.3540

**Notes:**

1. Color coordinates measurement allowance is  $\pm 0.01$ .
2. One delivery will include up to two consecutive color ranks and three luminous intensity ranks of the products the quantity-ratio of the ranks is decided by **LuckyLight**.

## Reliability Test Items And Conditions:

The reliability of products shall be satisfied with items listed below:

Confidence level: 90%.

LTPD: 10%.

### 1) Test Items and Results:

No.	Test Item	Test Hours/Cycles	Test Conditions	Sample Size	Ac/Re
1	Resistance to Soldering Heat	6 Min	Tsld=260±5 , Min. 5sec	25pcs	0/1
2	Thermal Shock	300 Cycles	H: +100 5min ∫ 10sec L: -10 5min	25pcs	0/1
3	Temperature Cycle	300 Cycles	H: +100 15min ∫ 5min L: -40 15min	25pcs	0/1
4	High Temperature Storage	1000Hrs.	Temp: 100	25pcs	0/1
5	DC Operating Life	1000Hrs.	IF=350mA	25pcs	0/1
6	Low Temperature Storage	1000Hrs.	Temp: -40	25pcs	0/1
7	High Temperature/ High Humidity	1000Hrs.	85 /85%RH	25pcs	0/1

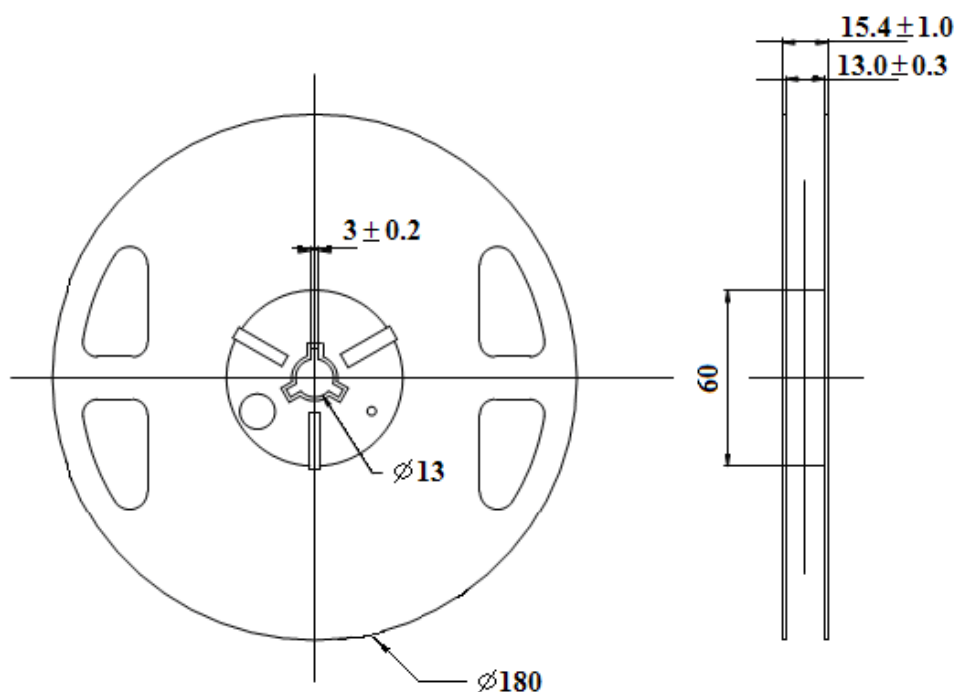
### 2) Criteria for Judging the Damage:

Item	Symbol	Test Conditions	Criteria for Judgment	
			Min	Max
Forward Voltage	VF	IF=350mA	---	F.V.*)×1.1
Reverse Current	IR	VR=5V	---	F.V.*)×2.0
Luminous Intensity	IV	IF=350mA	F.V.*)×0.7	---

\*) F.V.: First Value.



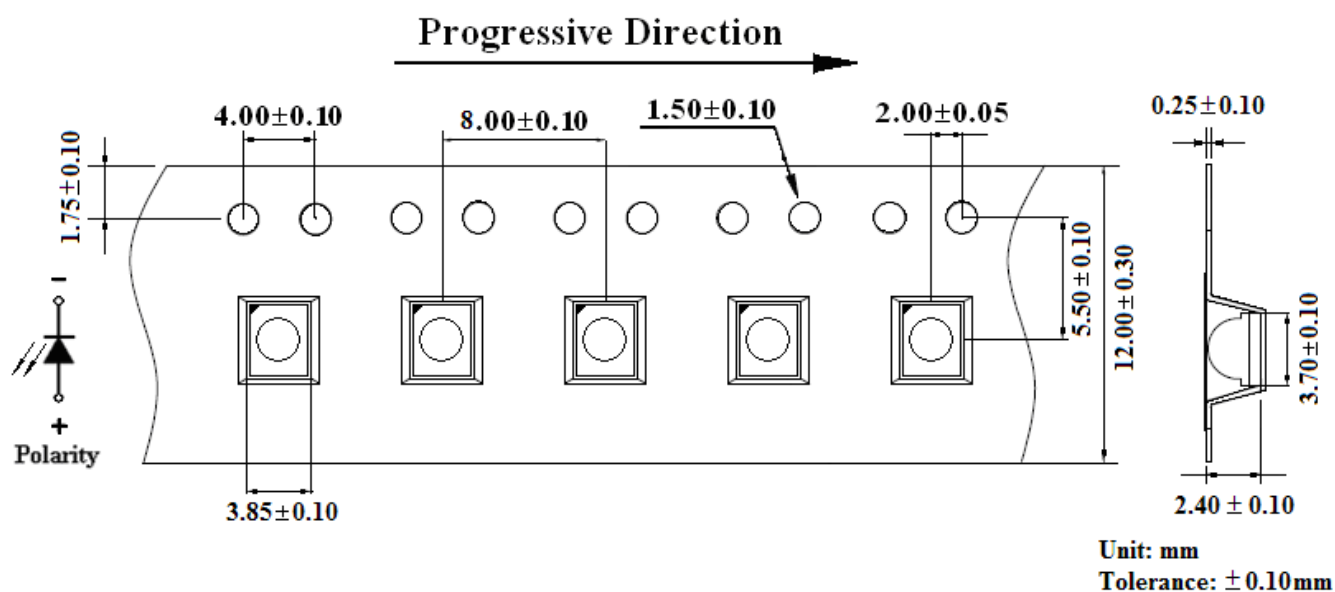
### Reel Dimensions:



Unit: mm  
Tolerance:  $\pm 0.25$ mm

### Carrier Tape Dimensions:

Loaded quantity 800 or 1000PCS per reel.



Unit: mm  
Tolerance:  $\pm 0.10$ mm

Please read the following notes before using the product:

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package, the LEDs should be kept at 30 °C or less and 80%RH or less.
- 2.3 The LEDs should be used within a year.
- 2.4 After opening the package, the LEDs should be kept at 30 °C or less and 60%RH or less.
- 2.5 The LEDs should be used within 168 hours (7 days) after opening the package.
- 2.6 If the moisture adsorbent material has fabled away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions. Baking treatment: 60±5 °C for 24 hours.

3. Soldering Condition

When soldering, for Lamp without stopper type and must be leave a minimum of 3mm clearance from the base of the lens to the soldering point.

To avoided the Epoxy climb up on lead frame and was impact to non-soldering problem, dipping the lens into the solder must be avoided.

Do not apply any external stress to the lead frame during soldering while the LED is at high temperature.

Recommended soldering conditions:

Soldering Iron		Wave Soldering	
Temperature	300 Max.	Pre-heat	100 Max.
Soldering Time	3 sec. Max. (one time only)	Pre-heat Time	60 sec. Max.
		Solder Wave	260 Max.
		Soldering Time	5 sec. Max.

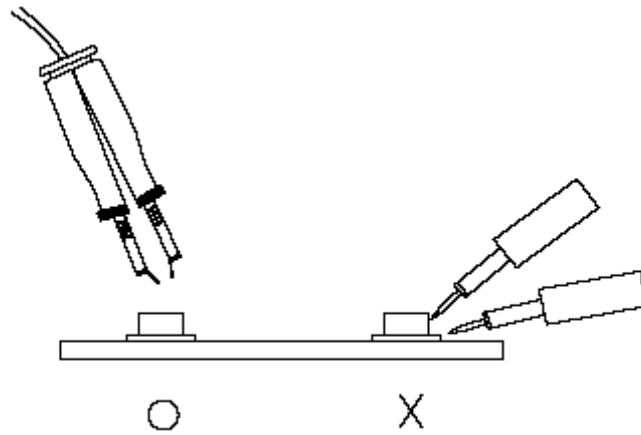
Note: Excessive soldering temperature and / or time might result in deformation of the LED lens or catastrophic failure of the LED.

4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 260 °C for 5 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



## 6. Caution in ESD

Static Electricity and surge damages the LED. It is recommended to use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.